# onsemi

# **MOSFET** - Power, Single N-Channel

# 80 V, 1.5 mΩ, 255 A

# NTMTS1D5N08H

### Features

- Small Footprint (8x8 mm) for Compact Design
- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses
- These Devices are Pb-Free and are RoHS Compliant

#### MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V <sub>DSS</sub>	80	V
Gate-to-Source Voltage			V <sub>GS</sub>	±20	V
Continuous Drain		$T_C = 25^{\circ}C$	I <sub>D</sub>	255	А
Current R <sub>θJC</sub> (Notes 1, 3)	Steady	T <sub>C</sub> = 100°C		162	
Power Dissipation	State	T <sub>C</sub> = 25°C	PD	208	W
$R_{\theta JC}$ (Note 1)		$T_{C} = 100^{\circ}C$		83	
Continuous Drain		$T_A = 25^{\circ}C$	۱ <sub>D</sub>	36	А
Current R <sub>0JA</sub> (Notes 1, 2, 3)	Steady	T <sub>A</sub> = 100°C		23	
Power Dissipation $R_{\theta JA}$ (Notes 1, 2)	State	T <sub>A</sub> = 25°C	PD	4.2	W
		T <sub>A</sub> = 100°C		1.7	
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \ \mu s$		I <sub>DM</sub>	900	А
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	–55 to +150	°C
Source Current (Body Diode)			۱ <sub>S</sub>	173	А
Single Pulse Drain-to-Source Avalanche Energy (L = 3 mH, $I_{L(pk)}$ = 32 A)			E <sub>AS</sub>	1536	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

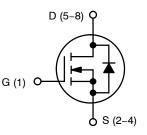
#### THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	0.6	°C/W
Junction-to-Ambient - Steady State (Note 2)	Reia	30	1

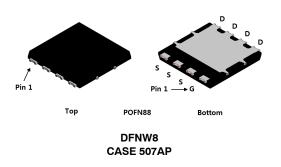
 The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
 Surface-mounted on FR4 board using a 650 mm<sup>2</sup>, 2 oz. Cu pad.

 Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

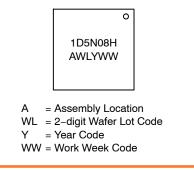
V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
80 V	1.5 m $\Omega$ @ 10 V	255 A



N-CHANNEL MOSFET



## MARKING DIAGRAM



## **ORDERING INFORMATION**

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

#### ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Мах	Unit
OFF CHARACTERISTICS					•		
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, I <sub>D</sub> = 250 $\mu$ A		80			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> / T <sub>J</sub>				59		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 80 V	T <sub>J</sub> = 25 °C			10	μΑ
Gate-to-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub>	$T_{\rm J} = 125^{\circ}{\rm C}$			250 100	nA
ON CHARACTERISTICS (Note 4)	-635	•DS = 0 •, •GS	5 - 20 1			100	10.1
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> :	= 490 uA	2.0	3.0	4.0	V
Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>		1		-6.9		mV/°C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 90 A		1.16	1.5	
	20(01)	V <sub>GS</sub> = 6 V	I <sub>D</sub> = 49 A		1.68	mΩ	
Forward Transconductance	9 <sub>FS</sub>	V <sub>DS</sub> = 5 V, I <sub>D</sub>	5		294		S
CHARGES, CAPACITANCES & GATE RE							
Input Capacitance	C <sub>ISS</sub>	V <sub>GS</sub> = 0 V, f = 1 MHz, V <sub>DS</sub> = 40 V			8220		
Output Capacitance	C <sub>OSS</sub>				1190		pF
Reverse Transfer Capacitance	C <sub>RSS</sub>				31		
Total Gate Charge	Q <sub>G(TOT)</sub>	V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 64 V; I <sub>D</sub> = 90 A			125		
Threshold Gate Charge	Q <sub>G(TH)</sub>				21		nC
Gate-to-Source Charge	Q <sub>GS</sub>				34		
Gate-to-Drain Charge	Q <sub>GD</sub>				29		
Plateau Voltage	V <sub>GP</sub>				4.5		V
SWITCHING CHARACTERISTICS (Note &	5)						
Turn–On Delay Time	t <sub>d(ON)</sub>	$V_{GS}$ = 10 V, $V_{DS}$ = 64 V, $I_{D}$ = 90 A, $R_{G}$ = 6 $\Omega$			33		
Rise Time	tr				23		
Turn-Off Delay Time	t <sub>d(OFF)</sub>				100		- ns
Fall Time	t <sub>f</sub>				30		
DRAIN-SOURCE DIODE CHARACTERIS	STICS						
Forward Diode Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0 V,	$T_J = 25^{\circ}C$		0.8	1.2	
		I <sub>S</sub> = 90 Å	T <sub>J</sub> = 125°C		0.7		V
Reverse Recovery Time	t <sub>RR</sub>	$V_{GS}$ = 0 V, dIS/dt = 100 A/µs, I <sub>S</sub> = 90 A			75		ns
Reverse Recovery Charge	Q <sub>RR</sub>				146		nC

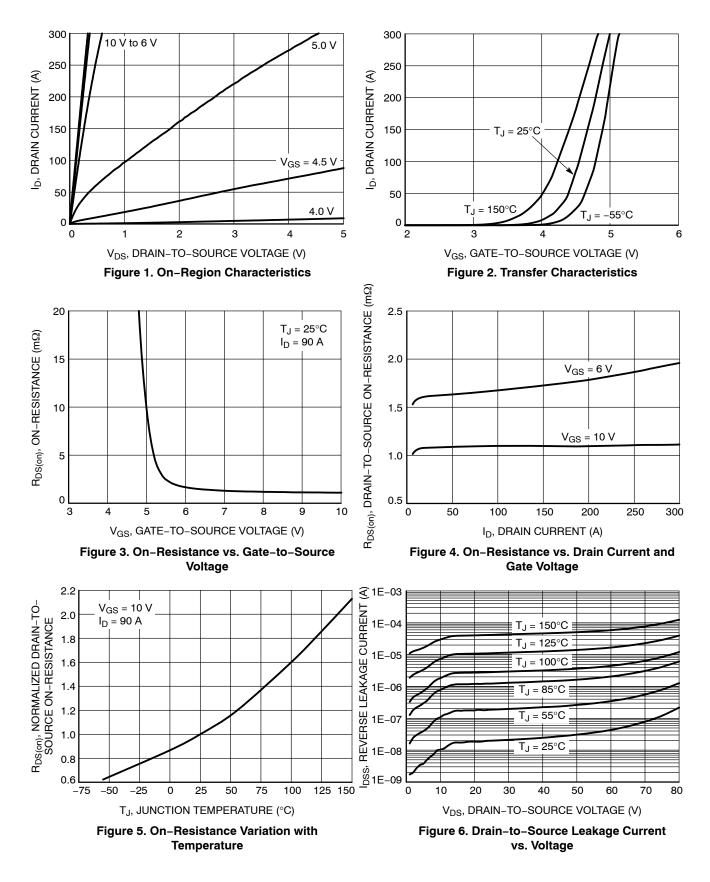
 

 Reverse Recovery Charge
 Q<sub>RR</sub>
 I<sub>S</sub> = 90 Å
 146
 nC

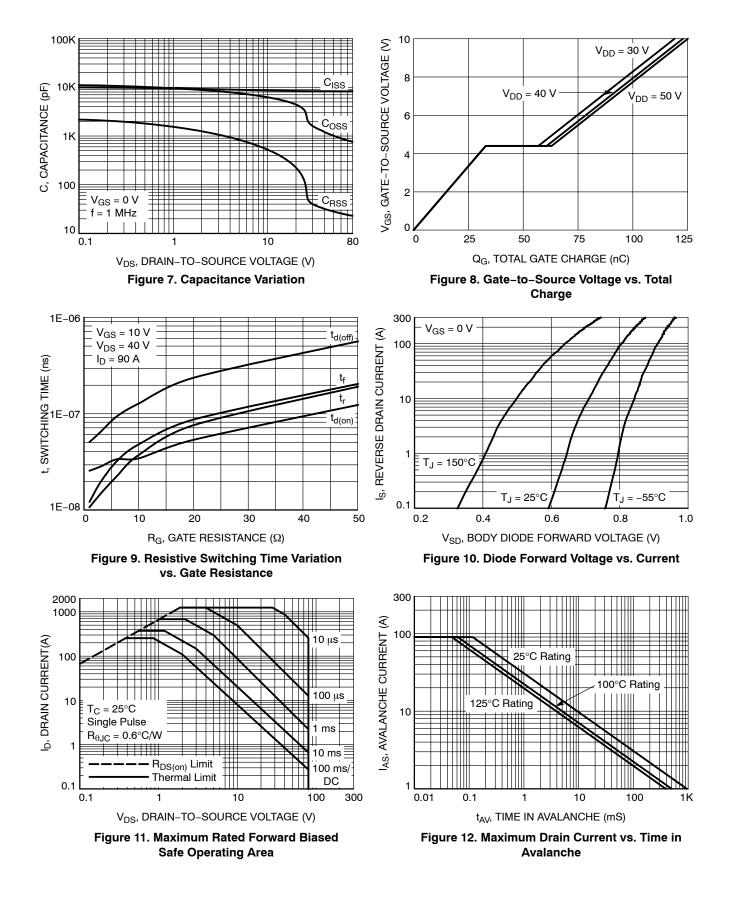
 Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product

 performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width  $\leq 300 \ \mu$ s, duty cycle  $\leq 2\%$ . 5. Switching characteristics are independent of operating junction temperatures.

# **TYPICAL CHARACTERISTICS**



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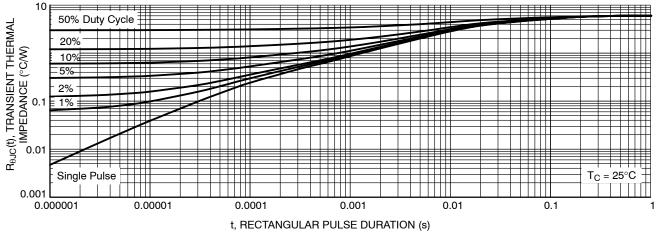


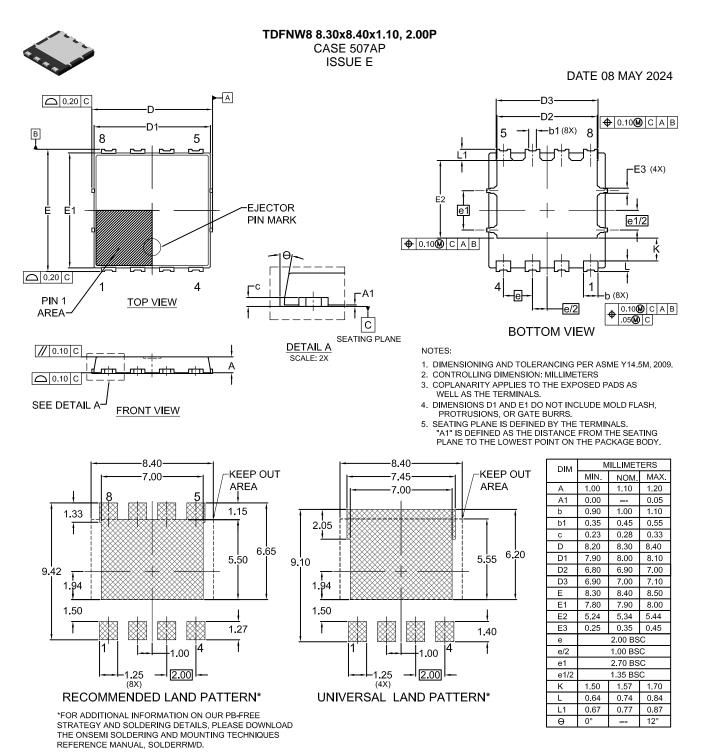
Figure 13. Thermal Response

#### **DEVICE ORDERING INFORMATION**

Device	Marking	Package	Shipping <sup>†</sup>
NTMTS1D5N08H	NTMTS1D5N08H	POWER 88 (Pb-Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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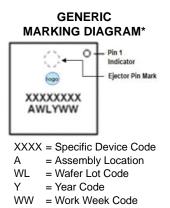
 
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DATE 08 MAY 2024



\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " •", may or may not be present. Some products may not follow the Generic Marking.

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